

## Is naïve building-block integration in strained glass PLC optimal?

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## Outline

To address our question, we shall require...

... a wafer-level perspective of buried-core glass waveguiding

- building the system: fabrication, materials, a “first look”
- detailed treatment: math & meshing (FEM)
- metrics & symmetries
  - waveguiding: isotropic & anisotropic
- integration – one step up
  - answering the question
  - device impact
- closing thoughts

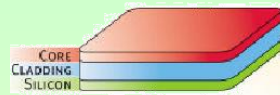


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## Wafer Fabrication Process



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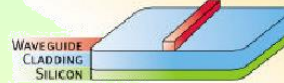
Bare Si wafer



Undercladding: oxidation

Lam & Zhou, *Lightwave Microsystems* whitepaper

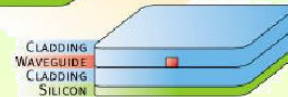
Core deposition



Pattern the core layer - lithography

Etch away extraneous material

Uppercladding deposition



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## Material Parameters



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Material	Thickness ( $\mu\text{m}$ ) $t$	Young's modulus (GPa) $E$	Poisson's ratio $\nu$	Thermal expansion coefficient ( $10^{-6}/\text{K}$ ) $\alpha$
BPSG	23	65	0.17	3.43
SiO <sub>2</sub>	13	72.5	0.17	0.55
Si	650	130	0.28	3.9
SiO <sub>2</sub>	15	72.5	0.17	0.55

Dominant effects: differential thermo-mechanical properties...

- break local symmetries
- couple across multiple length scales



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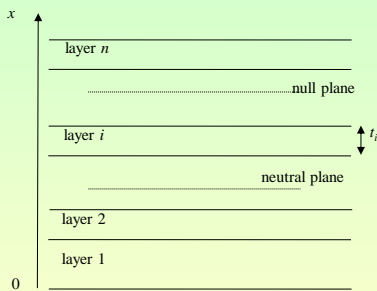
## Some light stretching exercises to warm up...



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## Structural Mechanics – no waveguide

### Planar multilayers



$$\sigma_i(x) = E'_i \varepsilon_i(x), \quad E'_i = \left( \frac{E_i}{1 - \nu_i} \right)$$

Biaxial stress

Biaxial modulus

$$\varepsilon_{i,0} = - \int_{T_{ref}}^T \alpha_i(T) dT$$

Layer macro-strain (flat)

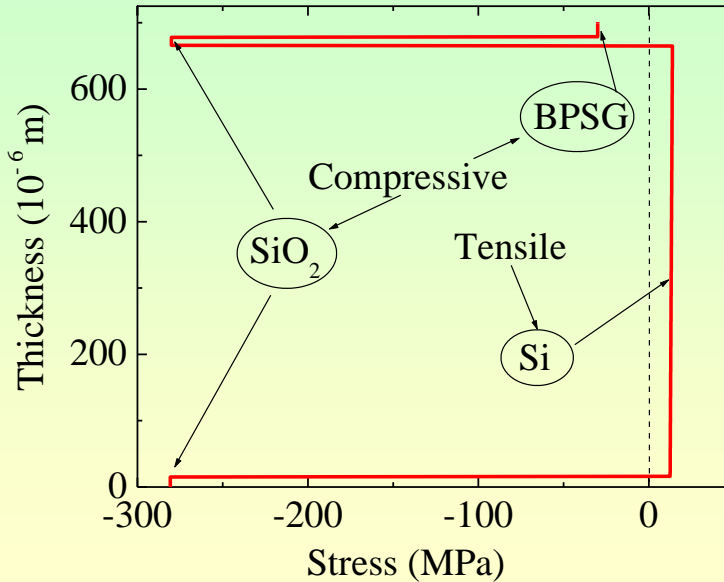
Weighted average strain

Wafer curvature

$$\sigma_i(x) = E'_i [(\varepsilon_{i,0} - \bar{\varepsilon}_0) + (x_N - x)K]$$



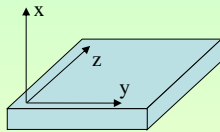
## Multilayer Stresses



## Simple waveguiding...



Maxwell's Equations:  $\nabla \times \tilde{\mathbf{E}} = -\mu_0 \frac{\partial \tilde{\mathbf{H}}}{\partial t}$      $\nabla \times \tilde{\mathbf{H}} = \epsilon_0 \epsilon_r \frac{\partial \tilde{\mathbf{E}}}{\partial t}$



$\epsilon_r$ , relative permittivity tensor

Isotropic case:  $\epsilon_r \rightarrow n^2$

$$\tilde{\mathbf{E}} = \mathbf{E}(x, y) \exp[i(\omega t - \beta z)]$$

$$\tilde{\mathbf{H}} = \mathbf{H}(x, y) \exp[i(\omega t - \beta z)]$$

$$\omega = ck_0, \quad k_0 = 2\pi/\lambda_0$$

Isotropic slab:  $\frac{\partial \mathbf{E}}{\partial y} = 0, \frac{\partial \mathbf{H}}{\partial y} = 0$

Two independent electromagnetic modes

$$\text{TE: } \begin{cases} \frac{d^2 E_y}{dx^2} + (k_0^2 n^2 - \beta^2) E_y = 0 \\ E_x = E_z = H_y = 0 \\ H_x = -\frac{\beta}{\omega \mu_0} E_y, \quad H_z = \frac{i}{\omega \mu_0} \frac{dE_y}{dx} \end{cases}$$

TM: ...



## ...now the more serious math



"Oh, dear! Another tragic case of math anxiety!"

## Structural Mechanics – with waveguide

Total strain:

$$\boldsymbol{\varepsilon} = \boldsymbol{\varepsilon}_{el} + \boldsymbol{\varepsilon}_{th} + \boldsymbol{\varepsilon}_{in}$$

$$\boldsymbol{\sigma} = \begin{pmatrix} \sigma_x & \tau_{xy} & \tau_{xz} \\ \tau_{yx} & \sigma_y & \tau_{yz} \\ \tau_{zx} & \tau_{zy} & \sigma_z \end{pmatrix} = \mathbf{a} \nabla \mathbf{u} - \boldsymbol{\gamma}$$

Stress-strain relation:

$$\boldsymbol{\sigma} = \mathbf{D} \boldsymbol{\varepsilon}_{el}$$

$$\boldsymbol{\gamma} = \frac{E \alpha \Delta T}{1 - 2\nu} \mathbf{1}$$

$$\mathbf{u} = (u_x, u_y, u_z)$$

$$\Delta T = T - T_{ref}$$

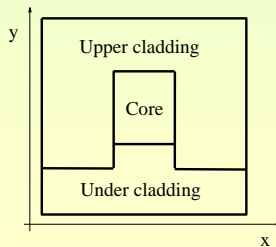
$$T_{ref} \sim 980^\circ C$$

Solve:

$$\rho \frac{\partial^2 \mathbf{u}}{\partial t^2} - \nabla \cdot \boldsymbol{\sigma} = \boldsymbol{\kappa}$$

...under generalized plane strain

$$\varepsilon_z = e_0 + e_1 x + e_2 y$$





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## ...not-so-simple waveguiding



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Full-Vector Maxwell's Equation's  $\nabla \times (\epsilon_r^{-1} \nabla \times \mathbf{H}) - k_0^2 \mu_r \mathbf{H} = 0$

$\mathbf{H}(x, y, z) = \mathbf{H}_t(x, y) \exp(-i\beta z)$  *Perpendicular Hybrid Modes*

$\mathbf{H}_t = H_{major} \hat{\mathbf{a}}_1 + H_{minor} \hat{\mathbf{a}}_2$  (minor)  $\uparrow$  Defines principle axes system  
(major)  $\rightarrow$   $\mathbf{I}$

Relative permittivity tensor:

$$\epsilon_r = \begin{pmatrix} [n - C_1 \sigma_x - C_2 (\sigma_y + \sigma_z)]^2 & 2n(C_2 - C_1) \tau_{xy} & 0 \\ 2n(C_2 - C_1) \tau_{xy} & [n - C_1 \sigma_y - C_2 (\sigma_z + \sigma_x)]^2 & 0 \\ 0 & 0 & [n - C_1 \sigma_z - C_2 (\sigma_x + \sigma_y)]^2 \end{pmatrix}$$

Photoelastic constants of silica glass (N/m<sup>2</sup>):

$$C_1 = 0.65 \times 10^{-12}, \quad C_2 = 4.2 \times 10^{-12}$$



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## The Finite element method – “sort-of”

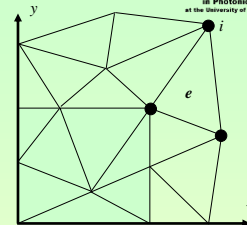


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Functional (scalar wave equation):

$$I[\phi] = \frac{1}{2} \int_{-\infty}^{\infty} \int_{-\infty}^{\infty} \left[ \left( \frac{\partial \phi}{\partial x} \right)^2 + \left( \frac{\partial \phi}{\partial y} \right)^2 - (k^2 n^2 - \beta^2) \phi^2 \right] dx dy$$

$$\left\{ \phi_{pert}(x, y) = \phi(x, y) + \delta \eta(x, y), \quad \lim_{\delta \rightarrow 0} \left( \frac{\partial}{\partial \delta} I[\phi_{pert}] \right) = 0 \right\}$$



Approx. field in each element as:  $\phi(x, y) = p_0^e + p_1^e x + p_2^e y$

...calculate functional, , for each element, then:  $I = \sum_{e=1}^Z I^e$

...obtain stationary condition:  $\frac{\partial I}{\partial \phi_i} = \sum_{j=1}^N c_{ij} \phi_j = 0$

...in matrix form:  $\mathbf{C} \{ \phi \} = \{ 0 \}$

Algebraic eigenvalue problem:  $\det(\mathbf{C}) = 0$   
 $\uparrow \rightarrow (\mathbf{A} - \lambda \mathbf{I}) \{ \phi \} = 0$



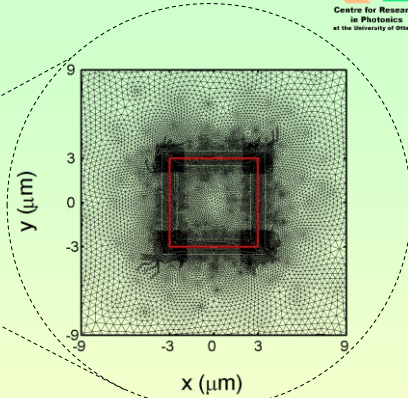
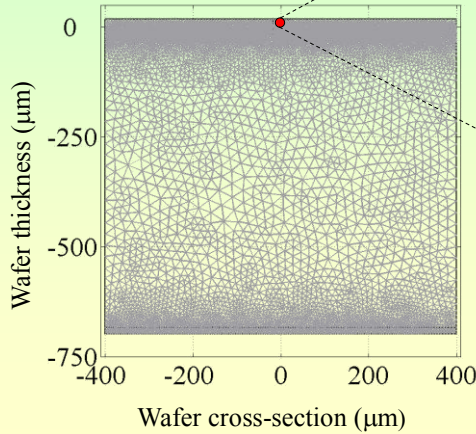


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## Meshing



Structural – full wafer  
~10,000 nodes



EM mode region  
~150,000 nodes

Memory requirements?  
~3 GB



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## Two simple metrics...



*Birefringence*

$$B = n_{eff}^{TM} - n_{eff}^{TE}$$

Effective index:

$$\frac{\beta}{k_0} = n_{eff}$$

*Optical Power*

$$P = \iint_S \frac{1}{2} \text{Re} \{ (\mathbf{E} \times \mathbf{H}^*) \cdot \hat{\mathbf{a}}_z \} dS$$

↑  
Total power (any given mode)  
through a surface  $S$ .

Power flow density:

$$P'(x, y) = \frac{1}{2} (E_x H_y - H_x E_y)$$

Relative difference in power densities  
(between TM and TE modes)

$$\Delta P' = 10 \log_{10} \left( \frac{P'_{TM}}{P'_{TE}} \right)$$





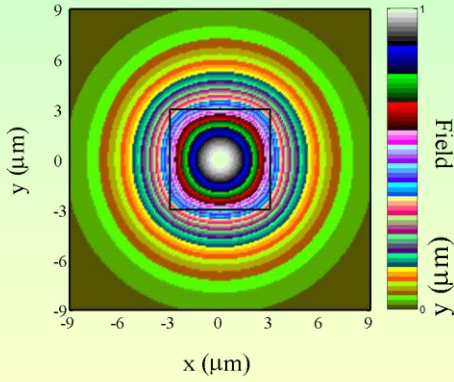
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## Simple symmetries – an isotropic waveguide



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*E*-field: major component

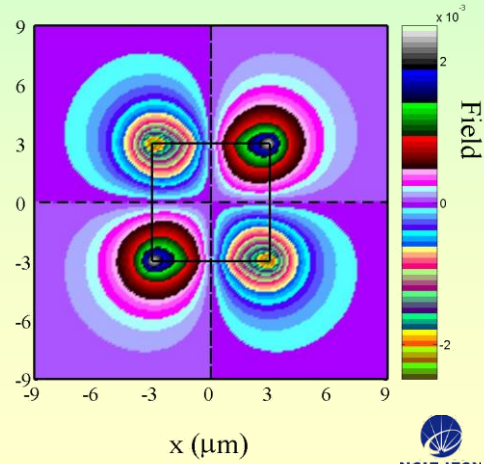


(6 x 6 core)

$$n_{core} = 1.455$$

$$n_{clad} = 1.445$$

*E*-field: minor component

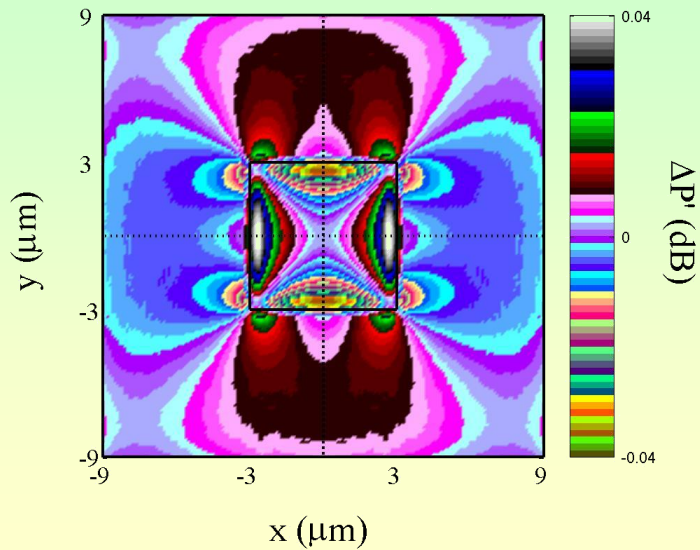


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## ...and its differential power density



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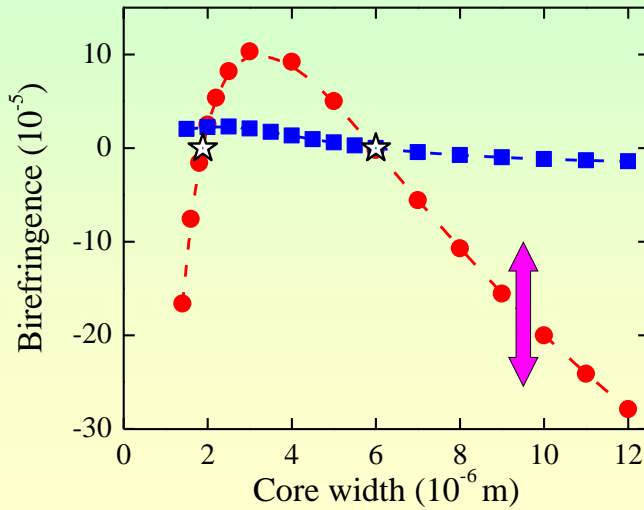


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## Breaking symmetries...



Rectangular core – effect of stress on form birefringence



- *pronounced effect*
- *design waveguide to match fab process*
- ⇒ *a tuning parameter*
- *two accidental degeneracies*



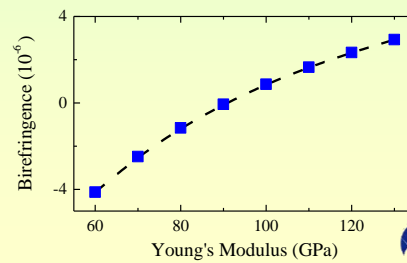
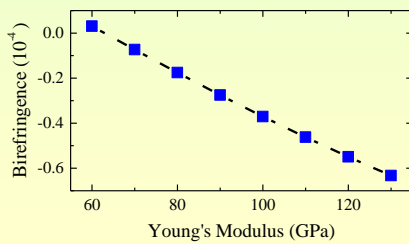
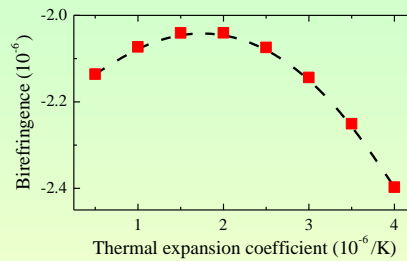
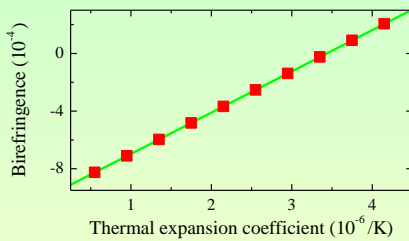
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## Material Sensitivity Analysis



*Fixed Core Properties*

*Fixed Upper Clad Properties*

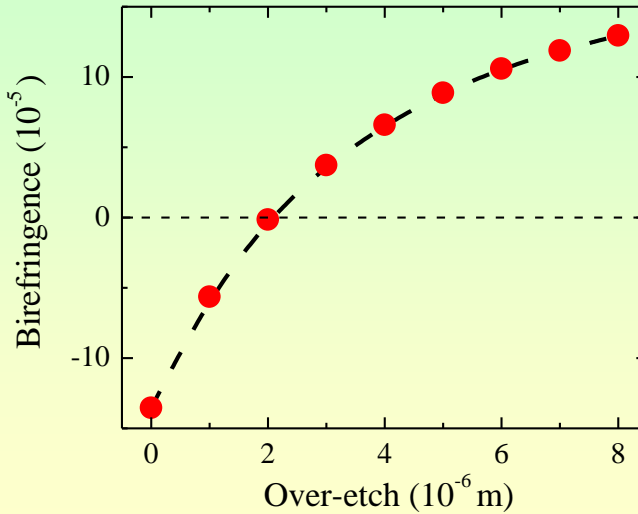




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## Indirect symmetry-breaking

Isolated square-core waveguide



➤ control the position of the neutral plane in fabrication...

⇒ a “tuning” parameter

...exploit differential thermal expansion through layer thickness

Schriemer & Cada, IEEE J. Quantum Electron., vol. 40, 1131-1139 (Aug. 2004)



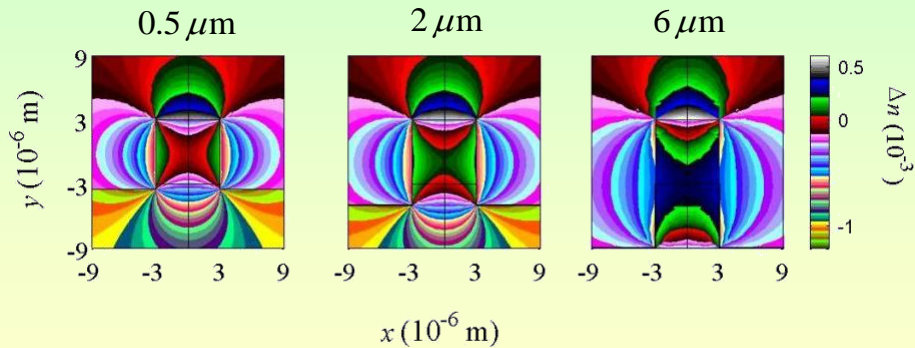
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## “Over-etch” tuning – physical origins



$$\text{Material birefringence: } \Delta n = n_x - n_y = (C_2 - C_1)(\sigma_x - \sigma_y)$$

Over-etch:



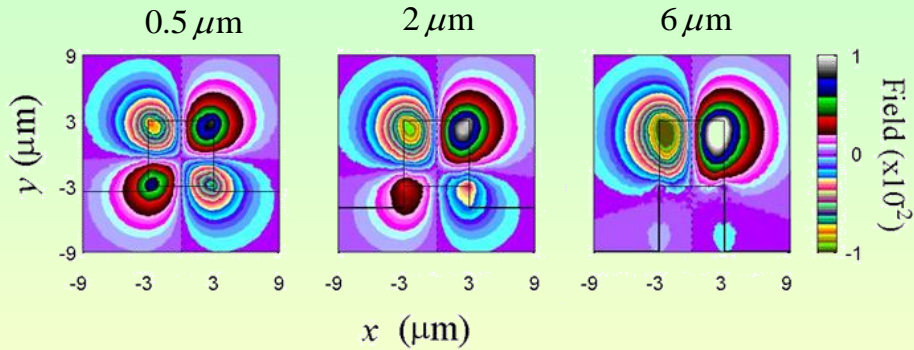
What is the impact on the eigenvector?





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## Minor field component

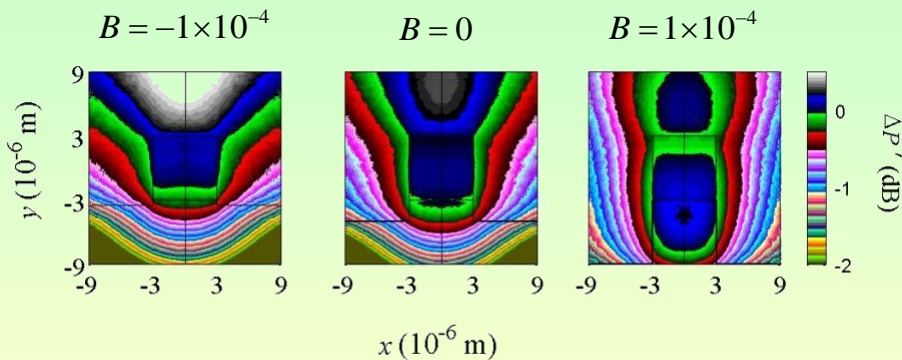


Symmetry-breaking of primarily geometrical origin...  
...enhanced by field-pinning due to shear strains  
(overwhelms nominal index discontinuities)



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## Differential power densities



Fundamental reduction in symmetry...

- smoothly lifted with increasing stress
- control energy density with over-etch



## Component Integration...

What is it...from a *physics* perspective?

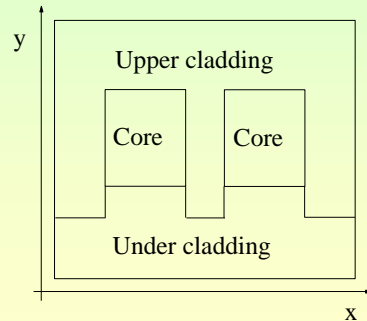
... a *spatially-compact method of controlling interlinked power flow trajectories with minimal information loss*

... *symmetry-breaking across spatial & temporal length scales*

The simplest example?

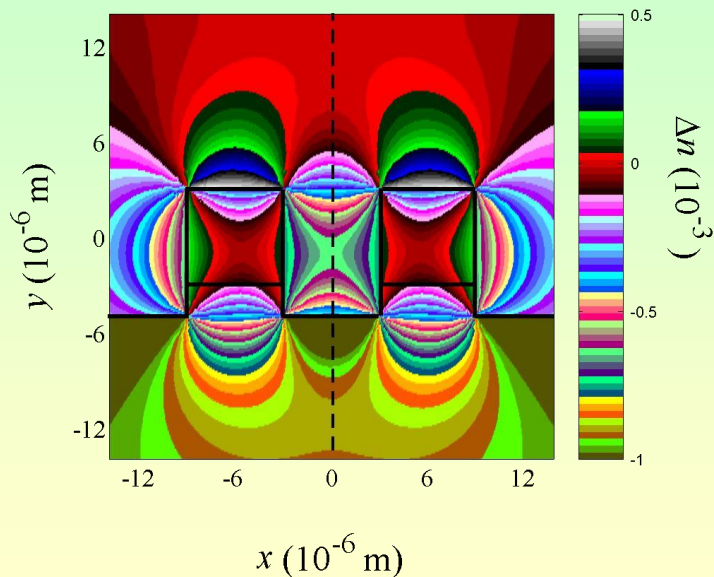
A *coupled* waveguide!

BUT: This discrete geometrical symmetry-breaking couples to a distributed material symmetry-breaking.



Is there a difference in optimal parameters?

## Material birefringence



## Optimize optical specifications

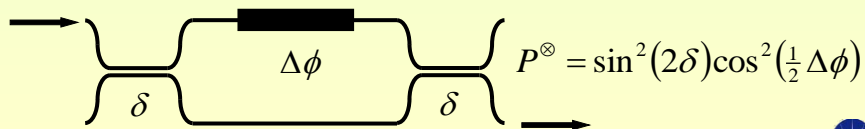
Consider supermodes of coupled waveguide...  
 ...under "optimal" isolated waveguide process.

Critical coupling length:  $L_c = \frac{\lambda_0}{2\Delta n}$ ,  $\Delta n = n_{\text{even}} - n_{\text{odd}}$   
 (...for TE & TM)

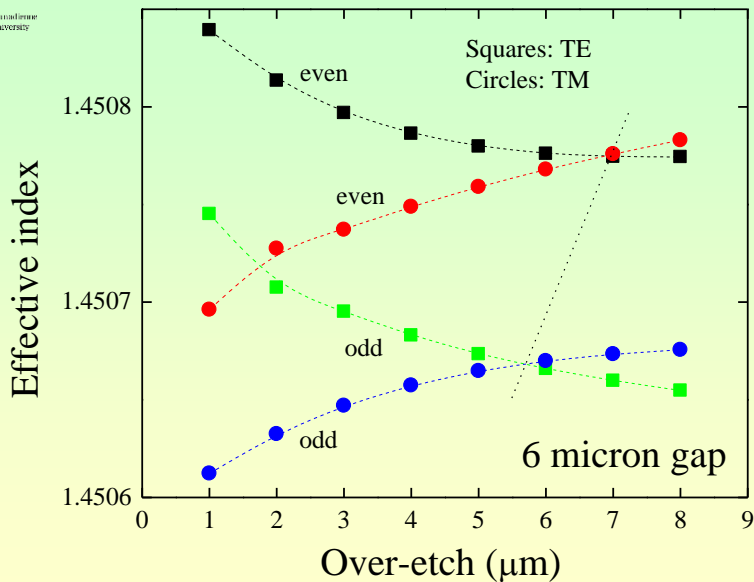
Building-block representation? An idealized directional coupler.

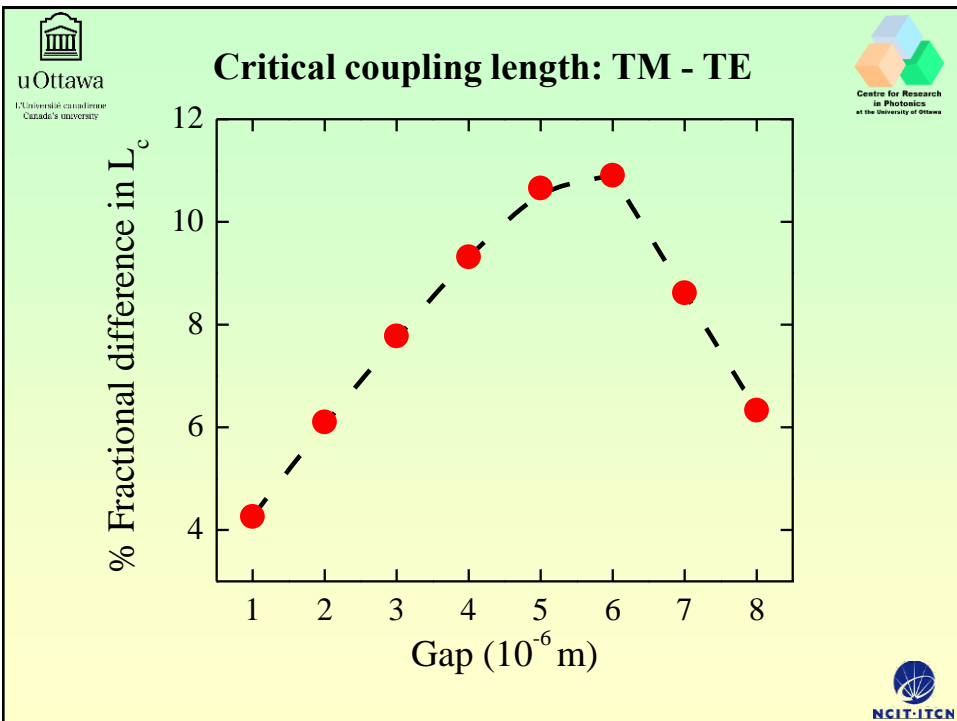
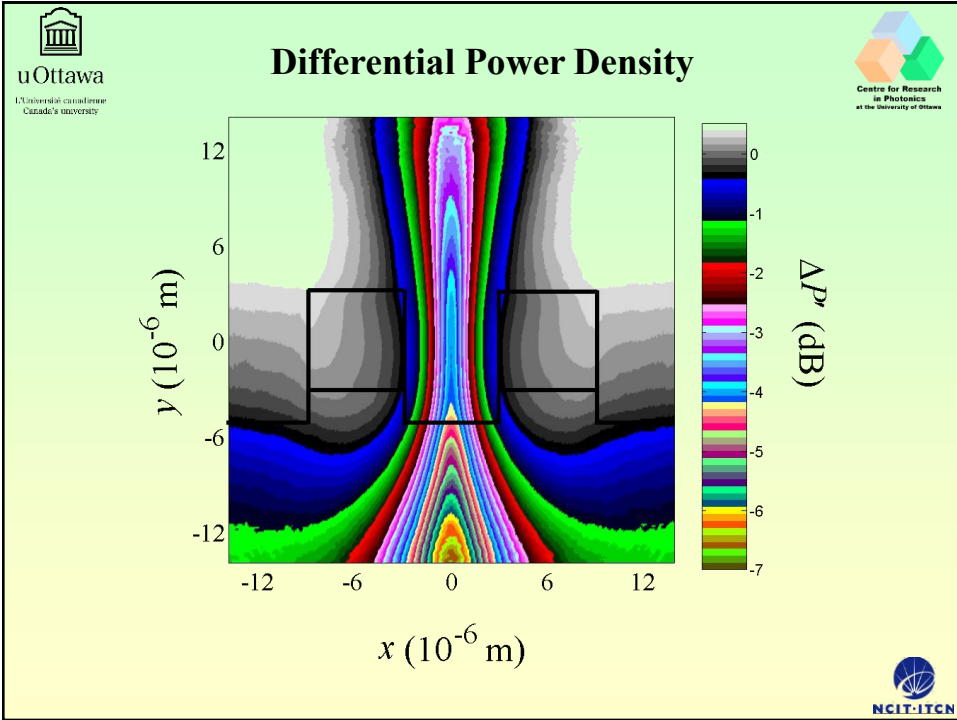
Is its operation "optimal" under the "isolated square waveguide"  
 fab process?

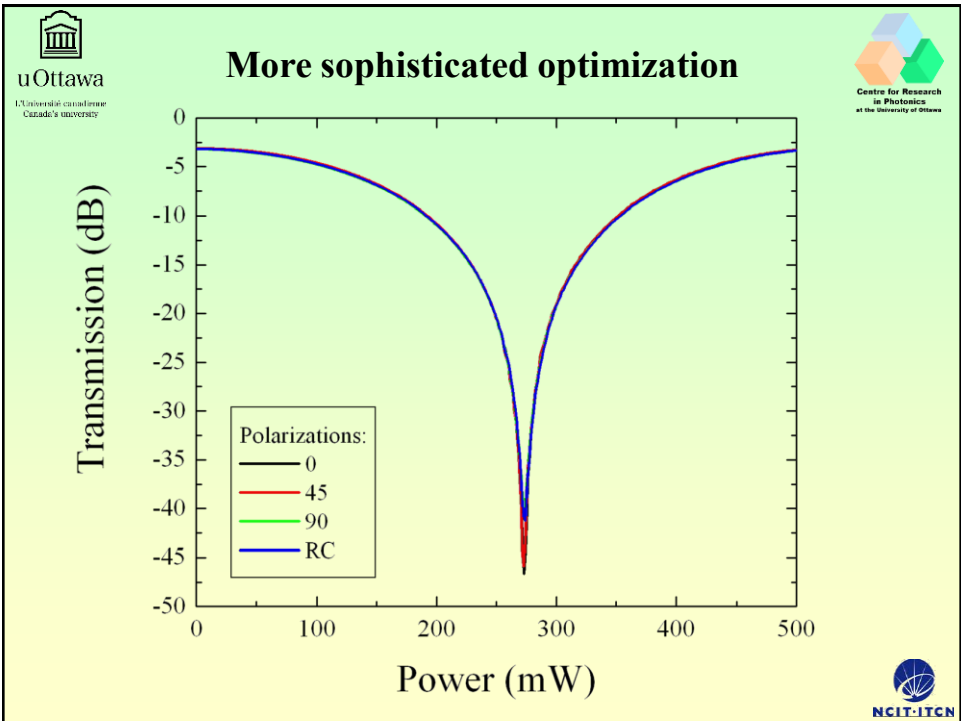
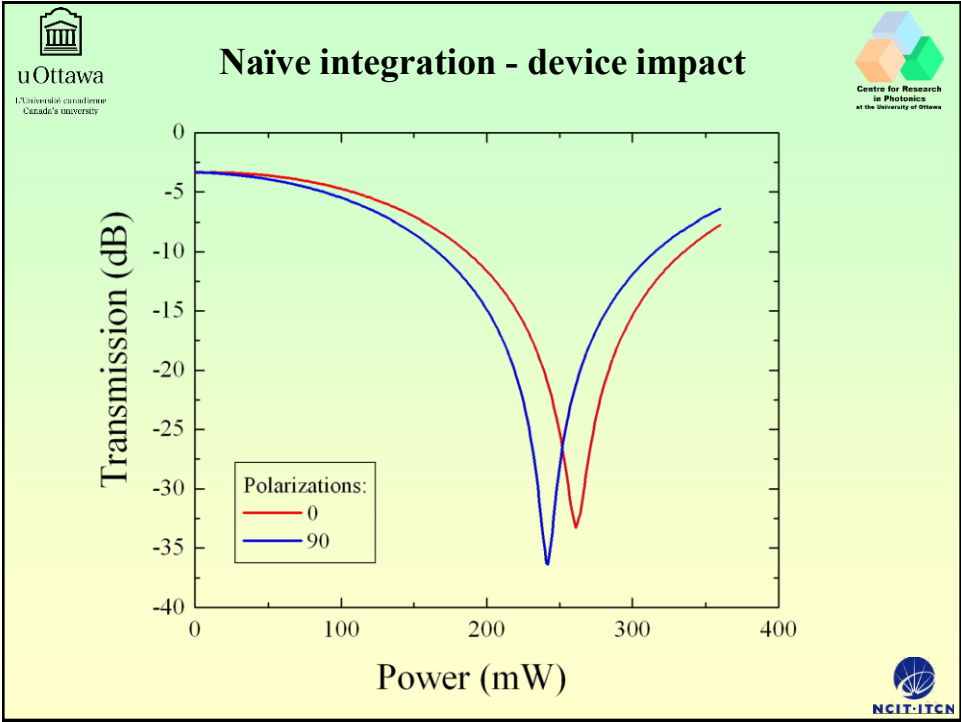
What is the device impact? Consider the VOA.



## Supermode indices







## Closing thoughts

- Naïve building block integration is NOT optimal
  - ...but integration may yet be achieved!
- Optimize within a “rich parameter space”
  - fab is digital
  - design is analogue
- Future prospects?
  - low-delta passive monolithic integration cannot meet current market cost points
  - high(er)-delta hybrid integration is the solution